

CONSUMER



Ultimate Versatility, Peak Reliability

Phison PS5029-E29T NAND flash controller IC solution uses the latest LDPC error-correcting technology to increase NAND compatibility to deliver SSDs with the highest reliability. Leveraging the power of PCIe Gen4, this DRAM-less series exceeds 7GB/s bandwidth while remaining power-and cost-efficient.

Application Handheld Gaming Notebooks **Business PCs**

PHISON P\$5029-E29T

Product Features

Market-leading Performance

Based on the Phison E27T, the E29T is optimized for applications requiring the most efficient data path for both performance and power. This product meets the 7GB/s requirement by utilizing PCIe Gen4x4 to deliver superior bandwidth and compatibility using the latest 3D NAND technology.

Superb Power Efficiency

Phison E29T offers the most competitive power efficiency, turning your notebook into an allday productivity weapon even when AC power is unavailable. The advanced management features such as L1.2 give your system extreme idle efficiency so you can stow your notebook without turning it off.

Outstanding Cost-effectiveness

Phison E29T can saturate the PCIe Gen4 interface bandwidth without a DRAM cache to ensure compelling cost savings for your design, creating design-in opportunities in the most cost-sensitive markets.

Phison 7th Generation LDPC ECC Engine

Phison's proprietary 7th-generation LDPC ECC engine operates on 4K frame sizes with increased spare NAND space. Additionally, support for advanced machine learning algorithms enhances performance and flexibility, assuring superior NAND flash reliability.

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CONTROLLER

PS5029-E29T

| Features | Specifications | | | |
|-------------------|--|--|--|--|
| Host Interface | PCle 4.0x4 (Bandwidth: 16GT/s x4) Backward compatible with existing PCle generation transfer rates Compliance with PCI Express Base Specification Revision 4.0 Compliance with NVMe 2.0 Host Memory Buffer (HMB) support | | | |
| Processor | - Single-CPU architecture with built-in 32-bit microcontroller - TSMC 12nm process technology | | | |
| Flash Controller | Up to 4 Channels with 16 Chip Enable (CE) counts Flash transfer rate up to 3600MT/s Capacity up to 8TB Support 3D TLC and QLC NAND flash memory Compliance with Toggle 5.1 and ONFi 5.1 Flash I/O operating voltage supply 1.2V | | | |
| Data Reliability | - Phison 7th generation LDPC ECC & RAID ECC - SRAM ECC engine - End-to-End Data Path Protection | | | |
| Security | - Pyrite - AES 256 - SHA 512 - RSA 4096 - TCG Opal | | | |
| Performance | - Sequential Read up to 7400MB/s - Sequential Write up to 6600MB/s - 4K Random Read up to 1000K IOPS - 4K Random Write up to 1400K IOPS | | | |
| Power Management | - L1.2 < 5mW | | | |
| Temperature Range | - Operating range: 0~70 °C - Storage range: -40~85 °C | | | |
| Package | - 228-ball FCCSP, 8.0mm x 12.5mm | | | |
| Peripheral | - Built-in internal thermal sensor - GPIO pins - Built-in UART function - I2C and SPI for external ROM - I3C supported | | | |



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Solutions PS5029-E29T

| SSD Solutions | PS5029-E29T | | | | |
|--|--------------------------------|------------|------------|------------|--|
| Capacity (1) | 512GB | 1TB | 2TB | 4TB | |
| Interface | PCle Gen 4.0 x4 NVMe 2.0 | | | | |
| Form Factor | M.2 2280 / M.2 2230 M.2 2280 | | | | |
| NAND Flash | 3D TLC / 3D QLC | | | | |
| | Performance ^{(2) (3)} | | | | |
| Sequential Read | 7200 MB/s | 7400 MB/s | 7400 MB/s | 7200 MB/s | |
| Sequential Write | 5000 MB/s | 6100 MB/s | 6400 MB/s | 6200 MB/s | |
| 4K Random Read | 530K IOPS | 1000K IOPS | 1000K IOPS | 950K IOPS | |
| 4K Random Write | 800K IOPS | 950K IOPS | 950K IOPS | 1400K IOPS | |
| | Power Consumption (4) | | | | |
| Supply Voltage | M.2 3.3V ± 5% | | | | |
| Active (Average) | 3850 mW | 4130 mW | 4150 mW | 4350 mW | |
| Idle | 50 mW | 50 mW | 50 mW | 50 mW | |
| Low Power PS4 (L1.2) | 5 mW | 5 mW | 5 mW | 5 mW | |
| | | Enviroi | nmental | | |
| Operating Temperature | 0°C - 70°C | | | | |
| Non-Operating Temperature | -40°C - 85°C | | | | |
| | Reliability & Warranty | | | | |
| TBW (5) | 300 TB | 600 TB | 1200 TB | 2400 TB | |
| MTBF | 1.5 million hours | | | | |
| UBER | <10 ⁻¹⁶ bits | | | | |
| | | Advance | d Features | | |
| - End-to-End Data Protection - TCG Pyrite Support - Thermal Monitoring | | | | | |

(1) 1 GB = 1,000,000,000 bytes

⁽²⁾ Sequential Performance is based on CrystalDiskMark 8.0.4, 1 GB range, QD=8, Thread=1, and test drive set as secondary
 ⁽³⁾ Random Performance is based on IOMeter, 1 GB range, 4K data size, QD=128, 16 worker, 4K aligned

⁽⁴⁾ Power consumption is measured during the sequential read and write operations performed by CrystalDiskMark with the conditions described in (2) ⁽⁵⁾ TBW is Total Bytes Written and the results are obtained in compliance with JESD218 Standards



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